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Docket No.: 27-035.D1

PATENT*Fee Sheet*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	John Briar	:	Confirmation No.:	2274
Serial No.:	10/693,217	:	Art Unit:	2811
Filed:	10/24/2003	:	Examiner:	Douglas W. Owens
For:	FLIP CHIP MOLDED/EXPOSED DIE PROCESS AND PACKAGE STRUCTURE			

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE /AMENDMENT

Sir:

The following Amendment and Remarks are submitted under 37 C.F.R. §1.111 in response to the Office Action mailed December 10, 2004, following the amendment format set forth under 37 CFR §1.121. After this introductory section, there are Amendments to the Specification, Amendments to the Claims, Amendments to the Drawings, and then Remarks, each starting on a separate page.

Amendments to the Specification consist of amendments for the Cross-Reference to Related Application(s) and Description of the Preferred Embodiment sections. Amendments to the Claims consist of the cancellation of claim 22 and amendments for claims 15, 20, and 21, which are incorporated in a complete listing of the claims.

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